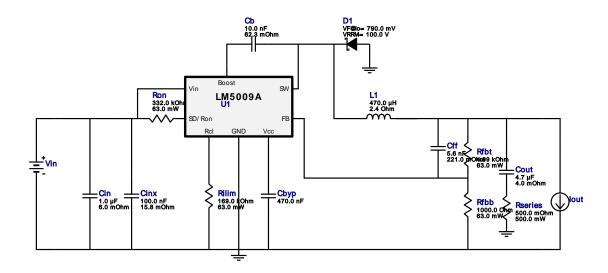


WEBENCH® Design Report

VinMin = 30.0V VinMax = 65.0V Vout = 15.0V Iout = 0.1A Device = LM5009MM/NOPB Topology = Buck Created = 2/9/14 3:59:49 PM BOM Cost = \$1.82 Footprint = 210.0 mm² BOM Count = 14 Total Pd = 0.15W

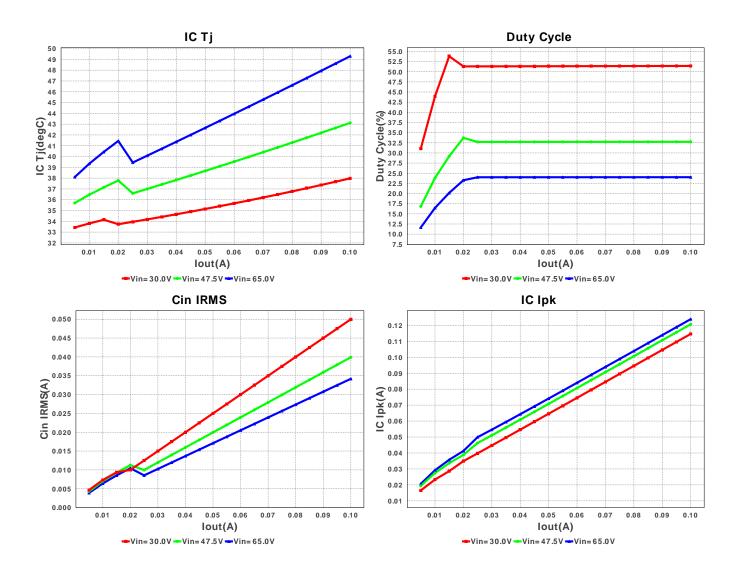
Design: 1231947/58 LM5009MM/NOPB LM5009MM/NOPB 30.0V-65.0V to 15.0V @ 0.1A

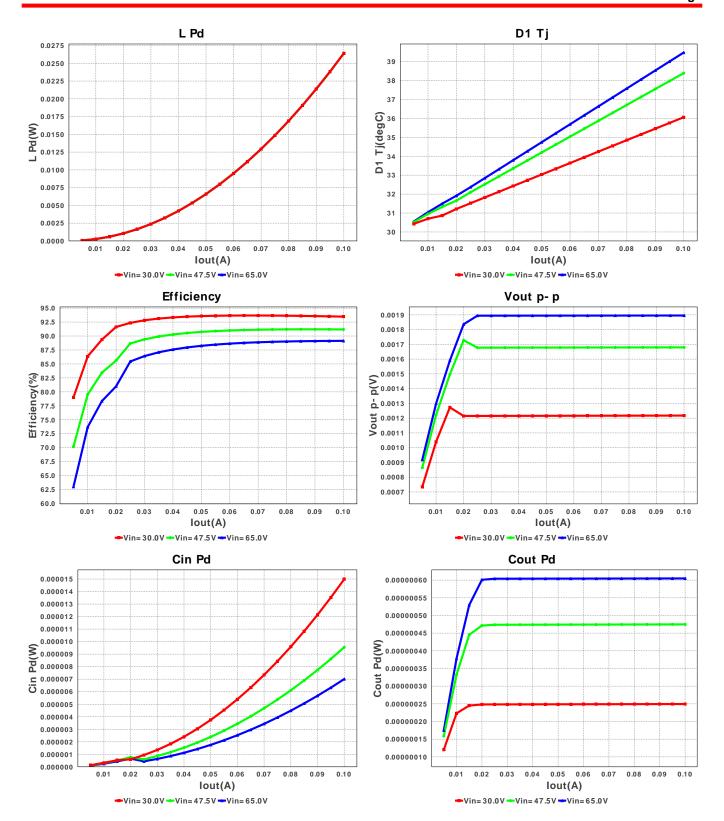


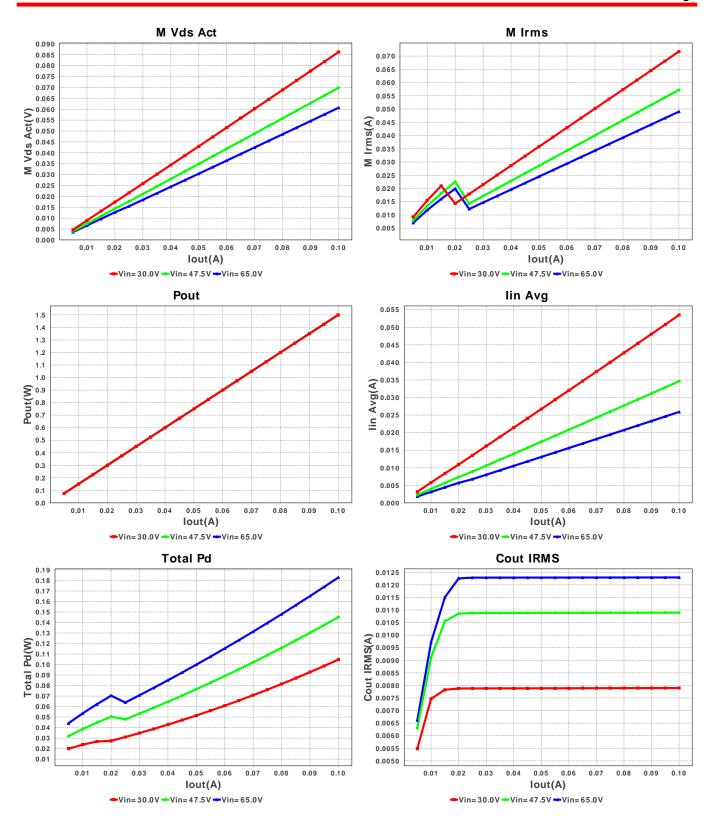
Electrical BOM

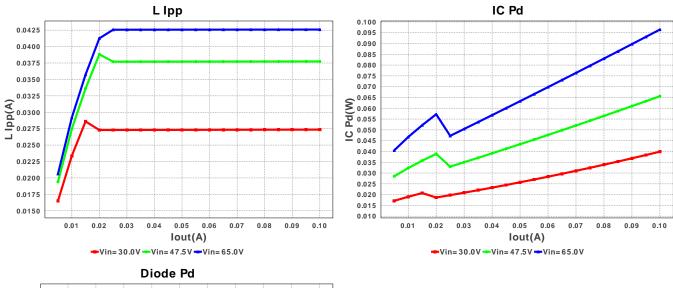
#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
1.	Cb	TDK	C1005X7R1C103K Series= X7R	Cap= 10.0 nF ESR= 62.3 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	0402 3 mm ²
2.	Cbyp	Taiyo Yuden	EMK212B7474KD-T Series= X7R	Cap= 470.0 nF VDC= 16.0 V IRMS= 0.0 A	1	\$0.02	0805 7 mm ²
3.	Cff	Kemet	C1206C562K5RACTU Series= X7R	Cap= 5.6 nF ESR= 221.0 mOhm VDC= 50.0 V IRMS= 326.0 mA	1	\$0.06	1206 11 mm ²
4.	Cin	TDK	C3216X7R2A105M Series= 285	Cap= 1.0 uF ESR= 6.0 mOhm VDC= 100.0 V IRMS= 4.5 A	1	\$0.11	1206 11 mm ²
5.	Cinx	TDK	C2012X7R2A104K Series= X7R	Cap= 100.0 nF ESR= 15.8 mOhm VDC= 100.0 V IRMS= 0.0 A	1	\$0.03	0805 7 mm ²
6.	Cout	MuRata	GRM21BR61E475KA12L Series= X5R	Cap= 4.7 uF ESR= 4.0 mOhm VDC= 25.0 V IRMS= 0.0 A	1	\$0.05	0805 7 mm ²
7.	D1	Diodes Inc.	B1100-13-F	VF@Io= 790.0 mV VRRM= 100.0 V	1	\$0.10	SMA 37 mm ²
8.	L1	Bourns	SRR7032-471M	L= 470.0 μH DCR= 2.4 Ohm	1	\$0.25	SRR7032 81 mm ²
9.	Rfbb	Vishay-Dale	CRCW04021K00FKED Series= CRCWe3	Res= 1000.0 Ohm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²

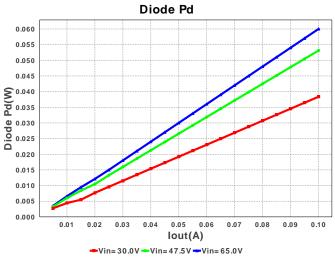
# Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
10. Rfbt	Vishay-Dale	CRCW04024K99FKED Series= CRCWe3	Res= 4.99 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²
11. Rilim	Vishay-Dale	CRCW0402169KFKED Series= CRCWe3	Res= 169.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²
12. Ron	Vishay-Dale	CRCW0402332KFKED Series= CRCWe3	Res= 332.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²
13. Rseries	Stackpole Electronics Inc	CSR1206FKR500 Series= ?	Res= 500.0 mOhm Power= 500.0 mW Tolerance= 1.0%	1	\$0.05	1206 11 mm ²
14. U1	Texas Instruments	LM5009MM/NOPB	Switcher	1	\$1.10	MUA08A 24 mm ²











Operating Values

Opo	operating values						
#	Name	Value	Category	Description			
1.	Cin IRMS	34.175 mA	Current	Input capacitor RMS ripple current			
2.	Cout IRMS	22.7 mA	Current	Output capacitor RMS ripple current			
3.	IC lpk	139.317 mA	Current	Peak switch current in IC			
4.	lin Avg	25.452 mA	Current	Average input current			
5.	L lpp	78.634 mA	Current	Peak-to-peak inductor ripple current			
6.	M1 Irms	49.013 mA	Current	Q lavg			
7.	BOM Count	14	General	Total Design BOM count			
8.	FootPrint	210.0 mm ²	General	Total Foot Print Area of BOM components			
9.	Frequency	325.0 kHz	General	Switching frequency			
10.	IC Tolerance	50.0 mV	General	IC Feedback Tolerance			
11.	M Vds Act	60.06 mV	General	Voltage drop across the MosFET			
12.	Pout	1.5 W	General	Total output power			
13.	Total BOM	\$1.82	General	Total BOM Cost			
14.	D1 Tj	39.484 degC	Op_Point	D1 junction temperature			
15.	Vout OP	15.0 V	Op_Point	Operational Output Voltage			
16.	Duty Cycle	24.023 %	Op_point	Duty cycle			
17.	Efficiency	90.667 %	Op_point	Steady state efficiency			
18.	IC Tj	43.596 degC	Op_point	IC junction temperature			
19.	ICThetaJA	200.0 degC/W	Op_point	IC junction-to-ambient thermal resistance			
20.	IOUT_OP	100.0 mA	Op_point	lout operating point			
21.	VIN_OP	65.0 V	Op_point	Vin operating point			
22.	Vout p-p	6.443 mV	Op_point	Peak-to-peak output ripple voltage			
23.	Cin Pd	7.007 µW	Power	Input capacitor power dissipation			
24.	Cout Pd	2.061 μW	Power	Output capacitor power dissipation			
25.	Diode Pd	60.022 mW	Power	Diode power dissipation			
26.	IC Pd	67.978 mW	Power	IC power dissipation			
27.	L Pd	26.4 mW	Power	Inductor power dissipation			
28.	Total Pd	154.403 mW	Power	Total Power Dissipation			

Design Inputs

#	Name	Value	Description
1.	lout	100.0 m	Maximum Output Current
2.	lout1	100.0 m	Output Current #1
3.	VinMax	65.0	Maximum input voltage
4.	VinMin	30.0	Minimum input voltage
5.	Vout	15.0	Output Voltage
6.	Vout1	15.0	Output Voltage #1
7.	base_pn	LM5009A	Base Product Number
8.	source	DC	Input Source Type
9.	Та	30.0	Ambient temperature

Design Assistance

- 1. For a Constant On Time device to be stable, we need to provide a ripple at the feedback comparator. There are various methods to implement the ripple. Depending on the circuit complexity vs. the allowable ripple, we have three options to choose from. The simplest option, 'Low Complexity', would require only a high ESR cap at the output. This means that the BOM count will be small, but the output voltage ripple will be quite large. The 'Optimal Solution' would require a feed-forward cap in parallel with the upper feedback resistor to AC couple the ripple to the feedback node. This increases the BOM count slightly, but now we have more control over the output voltage ripple. If the output voltage requirement is very tight, then the best option is to go for the 'Low Output Ripple' solution. In this option we can go with very low ESR output caps and have very good control over the output voltage ripple.
- 2. LM5009A Product Folder: http://www.ti.com/product/lm5009: contains the data sheet and other resources.

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